



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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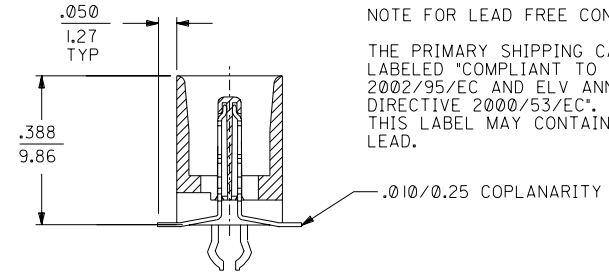


NOTES:

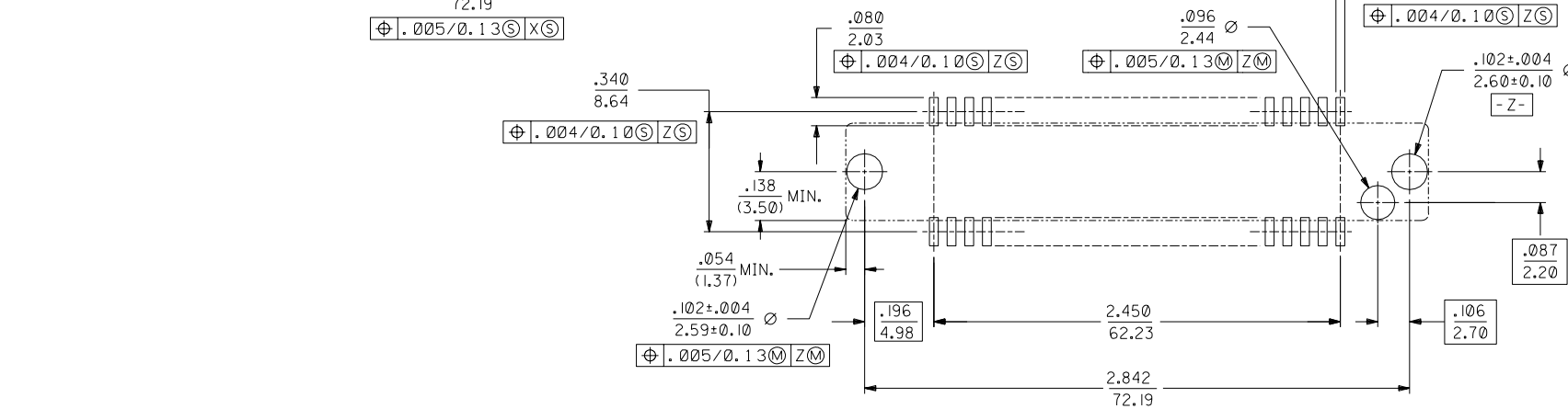
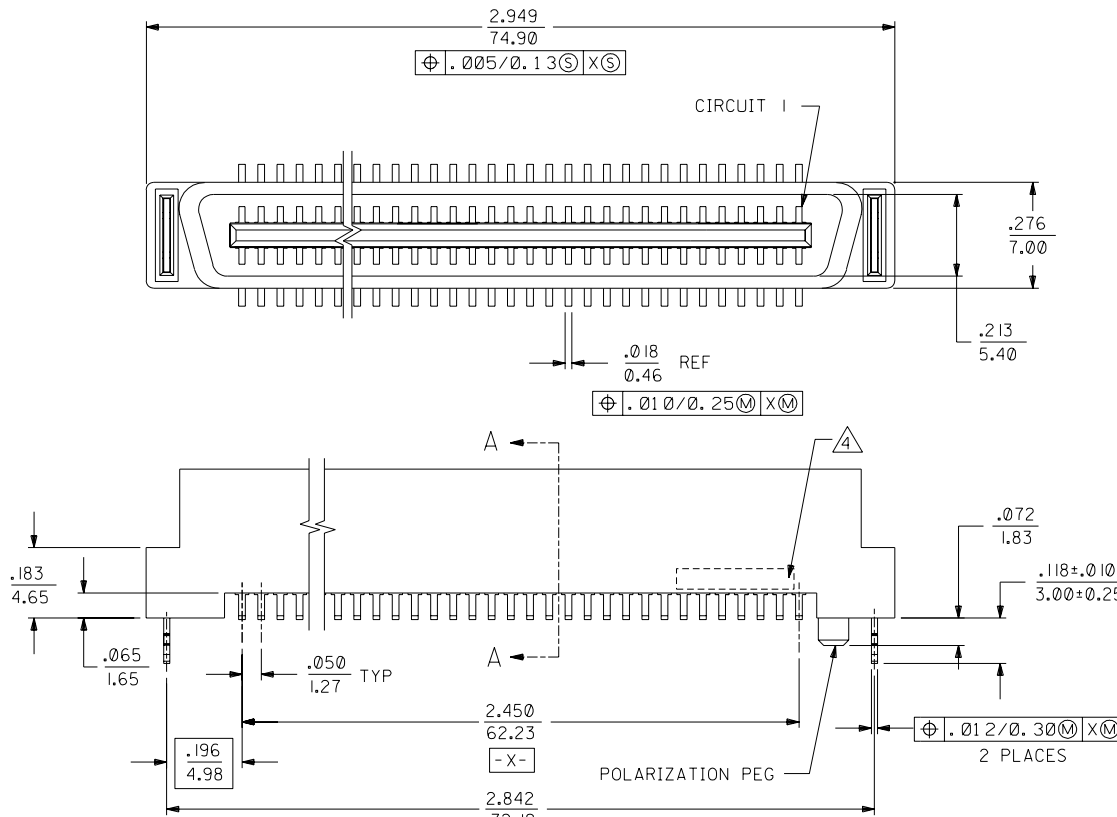
- 1) MATERIALS:  
HOUSING: I.R. COMPATIBLE POLYMER, GLASS FILLED,  
UL 94 V 0, BLACK  
TERMINALS: BRASS  
METAL PEGS- PHOSPHOR BRONZE.
- 2) PLATING:  
.000030/(0.00076) MINIMUM GOLD IN CONTACT AREA AND  
.000050/(0.00127) MINIMUM TIN IN TAIL AREA OVER  
.000075/(0.00191) MINIMUM NICKEL UNDERPLATING OVERALL.
- 3) ASSEMBLY MATES WITH MOLEX P/N SDA-71660-\*\*\*\*,  
CONFORMS TO PRODUCT SPECIFICATION PS-71660.
- 4) FOUR DIGIT DATE CODE (WK, YR), EXAMPLE => 26 96  
LOCATED IN AREA INDICATED.
- 5) PRODUCT PACKAGED PER PK-70873-055.

NOTE FOR LEAD FREE CONVERSION:

THE PRIMARY SHIPPING CARTON WILL BE  
LABELED "COMPLIANT TO ROHS DIRECTIVE  
2002/95/EC AND ELV ANNEX II OF  
DIRECTIVE 2000/53/EC". CARTONS WITHOUT  
THIS LABEL MAY CONTAIN PRODUCT WITH  
LEAD.



SECTION A-A  
SCALE 4:1



F	LEAD FREE CONV. ECN UCP2004-2096 RKADAMS 04/04/23
E	CHANGED PK SPEC. ECN UCP2003-1596 RWHITE 03/02/06
D	ADD PEG LNCHT DIM ECN UDT2002-1289 BBARKER 02/05/13
C	REV PACKAGING ECN UDT2000-1183 ACHAMMER 00/05/30
B	REVISED PER ECN UDT1999-1036 KSMITH 99/05/26
AI	REVISED PER ECN U70444 ACHAMMER 96-11-25
A	INITIAL RELEASE PER ECN U61057 3-1-96 RAN

DIMENSIONS SHOWN (METRIC) INCH		▽ = 0		= 0		MFG, SH, REV, LTR, REVISIONS	
UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°		REVISE ONLY ON CAD SYSTEM					
3 PLACE	± .005	INCH	METRIC	TITLE			
2 PLACE	± --- ± 0.13	SALES ASSEMBLY					
1 PLACE	--- ± ---	EBBI EXT. HEIGHT VERTICAL					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		100 CIRCUIT SMT CONNECTOR					
DRWG. BY	CHK'D. BY	FILE NAME	SHEET NO.	DATE	PART NO.		
RAN	RAN	71661-5910	1 OF 1	03/01/96	SDA-71661-5910		
APP'D. BY	SCALE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		DRW. NO.	DIV. SIZE		
GWF	4: 1			DA	C		